







PCM1822

ZHCSQ26 - MAY 2022

PCM1822 立体声通道、32 位、192 kHz、Burr-Brown™ 音频 ADC

1 特性

- 立体声高性能 ADC:
 - 2 通道模拟麦克风输入或线路输入
- ADC 线路和麦克风差分和单端输入性能:
 - PCM1822 动态范围:
 - 117 dB, 启用动态范围增强器
 - 111 dB,禁用动态范围增强器
 - THD+N: -95 dB
- 1V_{RMS}满量程输入
- ADC 采样率 (f_S) = 8 kHz 至 192 kHz
- 硬件引脚控制配置
- 线性相位或低延迟滤波器可选
- 灵活的音频串行数据接口:
 - 主或从接口可选
 - 32 位、2 通道 TDM
 - 32 位、2 通道 I²S
- 音频时钟丢失时自动断电
- 集成高性能音频 PLL
- 单电源运行:3.3V
- I/O 电源运行: 3.3V 或 1.8V
- 3.3V AVDD 电源电压下的功耗:
 - 16 kHz 采样率下为 19.6 mW/通道
 - 48 kHz 采样率下为 21.3 mW/通道

2 应用

- 智能扬声器
- DVD 录像机和播放器
- AV 接收机
- 视频会议系统
- IP 网络摄像头

3 说明

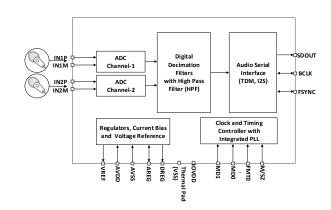
PCM1822 是一款高性能、Burr-Brown™ 音频模数转换 器 (ADC),可支持最多两个模拟通道的同步采样。该 器件支持单端和差分线路和麦克风输入,具有 1V_{RMS} 满量程信号,集成了锁相环 (PLL) 和直流滤除高通滤波 器 (HPF),并支持高达 192 kHz 的采样率。该器件支 持时分多路复用 (TDM) 或 I2S 音频格式,且硬件引脚 电平可选。此外, PCM1822 还支持主从模式选择,从 而实现音频总线接口操作。这些集成的高性能特性,以 及采用 3.3V 单电源供电的功能, 使该器件非常适用于 远场麦克风录音应用中对成本敏感的空间受限型音频系 统。

PCM1822 的额定工作温度范围为 - 40°C 至 +125°C, 并且采用 20 引脚 WQFN 封装。

器件信息(1)

器件型号	封装	封装尺寸(标称值)
PCM1822	WQFN (20)	3.00mm×3.00mm,间距 为 0.5mm

(1) 如需了解所有可用封装,请参阅数据表末尾的封装选项附录。



简化版方框图



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4 Revision History 注:以前版本的页码可能与当前版本的页码不同

表 4-1.

Date	Revision	Notes
May 2022	*	Initial release



5 Device Comparison Table

FEATURE	PCM1820	PCM1821	PCM1822	TLV320ADC3120	TLV320ADC5120	TLV320ADC6120		
Control interface		Pin control			I ² C			
Digital audio serial interface		TDM or I ² S		TDM	TDM or I ² S or left-justified (LJ)			
Audio analog channel				2				
Digital microphone channel		Not available			4			
Programmable MICBIAS voltage		N/A		Yes				
Dynamic range (DRE disabled)	113 dB	106 dB	111dB	106 dB	108 dB	113 dB		
Dynamic range (DRE enabled)	123 dB	Not available	117dB	Not available	120 dB	123 dB		
ADC SNR with DRE	123 dB	N/A	117dB	N/A	120 dB	123 dB		
Input Voltage	2V	rms	1V _{rms}		2V _{rms}			
Input Type	Differential		С	Differential/Single-Ende	ed			
Input impedance	2.5 k Ω	10 kΩ	2.5 k Ω	2.5 kΩ, 10 kΩ, 20 kΩ				
Compatibility	Pin-to-pin, packa	ge, drop-in replacem	nents of each other	Pin-to-pin, package, and control registers compatible; drop-in replacements of each other				
Package		WQF1	N (RTE), 20-pin, 3.00 n	nm × 3.00 mm (0.5-mi	m pitch)			



6 Pin Configuration and Functions

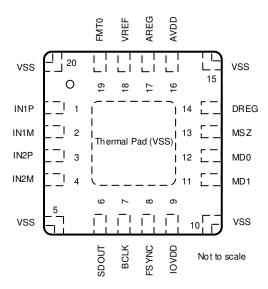


图 6-1. RTE Package, 20-Pin WQFN With Exposed Thermal Pad, Top View

表 6-1. Pin Functions

	PIN	TYPE	DESCRIPTION	
NO.			DESCRIPTION	
1	IN1P	Analog input	Analog input 1P pin.	
2	IN1M	Analog input	Analog input 1M pin.	
3	IN2P	Analog input	Analog input 2P pin.	
4	IN2M	Analog input	Analog input 2M pin.	
5	VSS	Analog Supply	Short this pin directly to the board ground plane.	
6	SDOUT	Digital output	Audio serial data interface bus output.	
7	BCLK	Digital I/O	Audio serial data interface bus bit clock.	
8	FSYNC	Digital I/O	Audio serial data interface bus frame synchronization signal.	
9	IOVDD	Digital supply	Digital I/O power supply (1.8 V or 3.3 V, nominal).	
10	VSS	Analog supply	Short this pin directly to the board ground plane.	
11	MD1	Digital input	Device configuration mode select 1 pin.	
12	MD0	Digital input	Device configuration mode select 0 pin.	
13	MSZ	Digital input	Audio interface bus master or slave select pin.	
14	DREG	Digital supply	Digital regulator output voltage for digital core supply (1.5 V, nominal).	
15	VSS	Analog supply	Short this pin directly to the board ground plane.	
16	AVDD	Analog supply	Analog power (3.3 V, nominal).	
17	AREG	Analog supply	Analog on-chip regulator output voltage for analog supply (1.8 V, nominal).	
18	VREF	Analog	Analog reference voltage filter output.	
19	FMT0	Digital input	Audio interface format select pin referred to AVDD supply.	
20	VSS	Analog supply	Short this pin directly to the board ground plane.	
Therma	l Pad (VSS)	Ground supply	Thermal pad shorted to internal device ground. Short thermal pad directly to board ground plane.	

7 Specifications

7.1 Absolute Maximum Ratings

over the operating ambient temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
	AVDD to AVSS	- 0.3	3.9	
Supply voltage	AREG to AVSS	- 0.3	2.0	V
	IOVDD to VSS (thermal pad)	- 0.3	3.9	
Ground voltage differences	AVSS to VSS (thermal pad)	- 0.3	0.3	V
Analog input voltage	Analog input pins voltage to AVSS	- 0.3	AVDD + 0.3	V
Digital input voltage	Digital input pins voltage to VSS (thermal pad)	- 0.3	IOVDD + 0.3	V
	Operating ambient, T _A	- 40	125	
Temperature	Junction, T _J	- 40	150	°C
	Storage, T _{stg}	- 65	150	

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
		±500	v	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

		MIN	NOM	MAX	UNIT	
POWER						
AVDD, AREG ⁽¹⁾	Analog supply voltage AVDD to AVSS (AREG is generated using onchip regulator) - AVDD 3.3-V operation	3.0	3.3	3.6	V	
IOVDD	IO supply voltage to VSS (thermal pad) - IOVDD 3.3-V operation	3.0	3.3	3.6	V	
ממעטו	IO supply voltage to VSS (thermal pad) - IOVDD 1.8-V operation	1.65	1.8	1.95	V	
INPUTS				'		
	Analog input pins and FMT0 voltage to VSS	0		AVDD	V	
	Digital input pins voltage(except FMT0) to VSS (thermal pad)	0		IOVDD	V	
TEMPERA	TURE			'		
T _A	Operating ambient temperature	- 40		125	°C	
OTHERS				'		
	Digital input pin used as MCLK input clock frequency			36.864	MHz	
C _L	Digital output load capacitance		20	50	pF	

(1) AVSS and VSS (thermal pad): all ground pins must be tied together and must not differ in voltage by more than 0.2 V.



7.4 Thermal Information

		PCM182x	
	THERMAL METRIC ⁽¹⁾	RTE (WQFN)	UNIT
		20 PINS	
R ₀ JA	Junction-to-ambient thermal resistance	55.9	°C/W
R _{θ JC(top)}	Junction-to-case (top) thermal resistance	33.1	°C/W
R _{θ JB}	Junction-to-board thermal resistance	23.4	°C/W
ΨJT	Junction-to-top characterization parameter	0.6	°C/W
ψ ЈВ	Junction-to-board characterization parameter	23.3	°C/W
R _{θ JC(bot)}	Junction-to-case (bottom) thermal resistance	16.7	°C/W

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

7.5 Electrical Characteristics

at T_A = 25°C, AVDD = 3.3 V, IOVDD = 3.3 V, f_{IN} = 1-kHz sinusoidal signal, f_S = 48 kHz, 32-bit audio data, BCLK = 256 × f_S , TDM slave mode (unless otherwise noted)

IN1 differential/single-ended input selected and AC signal shorted to ground, DRE disabled 105 111 1		PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Description	ADC CON	FIGURATION					
Full-scale AC signal voltage Differential/Single AC-coupled input AC-coupled input No.		AC input impedance	Input pins INxP or INxM		2.5		kΩ
Voltage Differential/Single Ended AC-coupled input 1	ADC PERF	FORMANCE FOR LINE, MICRO	PHONE INPUT RECORDING : AVDD 3.3-V OPERATION				
signal shorted to ground, DRE enabled (DRE_LVL = 110 117 117 117 118 118 119 117 118 118 119 119 119 111 117 118 118 118 119 119 111 118 119 111 118 119 111 118 118		voltage Differential/Single	AC-coupled input		1		V_{RMS}
IN1 differential/single-ended input selected and AC signal shorted to ground, DRE disabled Bynamic range, A-weighted ⁽²⁾ IN1 differential/single-ended input selected and - 60-dB full-scale AC signal input, DRE enabled (DRE_LVL = - 36 dB, DRE_MAXGAIN = 18 dB) IN1 differential/single-ended input selected and - 60-dB full-scale AC signal input, DRE disabled IN1 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE disabled IN1 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE disabled IN1 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE disabled IN2 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE disabled IN2 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE disabled IN2 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE disabled IN3 dB	SNR		signal shorted to ground, DRE enabled (DRE_LVL =	110	117		dB
Dynamic range, A- weighted (2) Dynamic range, A- weighted (2) Dynamic range, A- Dy		weigntea(1) (2)		105	111		
IN1 differential/single-ended input selected and - 60-dB full-scale AC signal input, DRE disabled IN1 differential/single-ended input selected and - 1-dB full-scale AC signal input, DRE enabled (DRE_LVL = -95 -80 full-scale AC signal input, DRE enabled (DRE_LVL = -95 full-scale AC signal input, DRE enabled (DRE_LVL = -95 full-scale AC signal input, DRE disabled full-scale AC signal input to non measurement channel isolation functionance full-scale AC-signal input to non measurement full-scale AC signal input full-scale	DR		full-scale AC signal input, DRE enabled (DRE_LVL = -		117		dB
HD+N Total harmonic distortion (2) (3) Hormonic distortion (2) (3) Hormonic distortion (3) Hormonic distortion (2) (3) Hormonic distortion (3) Hormoni		weighted			111		
IN1 differential/single-ended input selected and ~ 1-dB full-scale AC signal input, DRE disabled IDC OTHER PARAMETERS Output data sample rate Output data sample word length Interchannel isolation Interchannel gain mismatch Gain drift(4) Across temperature range ~40°C to 125°C Degrees Phase drift(6) Phase drift(6) Power-supply rejection ratio INOC OTHER PARAMETERS 7.35 192 KHZ 32 Bits 6 Bits 108 Bits AC-signal input to non measurement channel - 1-24 dB dB dB DEGREES To 1-dB full-scale AC-signal input to non measurement channel - 1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-	THD+N		full-scale AC signal input, DRE enabled (DRE_LVL =		- 95	- 80	dB
Output data sample rate Output data sample word length Interchannel isolation - 1-dB full-scale AC-signal input to non measurement channel Interchannel gain mismatch - 6-dB full-scale AC-signal input Gain drift(4) Across temperature range -40°C to 125°C Interchannel phase mismatch - 1-kHz sinusoidal signal - 1-kHz sinusoidal signal, across temperature range -40°C to 125°C Degrees Phase drift(5) 1-kHz sinusoidal signal, across temperature range -40°C to 125°C Degrees/ SRR Power-supply rejection ratio 100-mV _{PP} , 1-kHz sinusoidal signal on AVDD, differential input selected, 0-dB channel gain Common-mode rejection ratio Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output 7.35 192 kHz 32 Bits 102 dB					- 95		
Output data sample word length Dutput data sample word length 32 32 32 33 34 35 35 35 35 35 35	ADC OTHI	ER PARAMETERS					
length Interchannel isolation - 1-dB full-scale AC-signal input to non measurement channel Interchannel gain mismatch - 6-dB full-scale AC-signal input Gain drift ⁽⁴⁾ Across temperature range -40°C to 125°C Interchannel phase mismatch - 1-kHz sinusoidal signal Phase drift ⁽⁵⁾ - 1-kHz sinusoidal signal, across temperature range -40°C to 125°C Degrees Power-supply rejection ratio 100-mV _{PP} , 1-kHz sinusoidal signal on AVDD, differential input selected, 0-dB channel gain Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output dB dB dB		Output data sample rate		7.35		192	kHz
Interchannel gain mismatch Interchannel gain mismatch Gain drift ⁽⁴⁾ Across temperature range -40°C to 125°C Interchannel phase mismatch 1-kHz sinusoidal signal Phase drift ⁽⁵⁾ 1-kHz sinusoidal signal, across temperature range -40°C to 125°C Degrees Power-supply rejection ratio 100-mV _{PP} , 1-kHz sinusoidal signal on AVDD, differential input selected, 0-dB channel gain Common-mode rejection ratio Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output dB dB dB						32	Bits
Gain drift ⁽⁴⁾ Across temperature range -40°C to 125°C Interchannel phase mismatch 1-kHz sinusoidal signal 2.0.02 Degrees Phase drift ⁽⁵⁾ 1-kHz sinusoidal signal, across temperature range -40°C to 125°C 0.0005 Degrees/ Power-supply rejection ratio 100-mV _{PP} , 1-kHz sinusoidal signal on AVDD, differential input selected, 0-dB channel gain Common-mode rejection ratio Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output dB		Interchannel isolation	j .		- 124		dB
Interchannel phase mismatch 1-kHz sinusoidal signal 2.002 Degrees Phase drift ⁽⁵⁾ 1-kHz sinusoidal signal, across temperature range -40°C to 125°C 2.0005 Degrees/ Degrees/ 2.0005 Degrees/ 2.0005 Degrees/ Degrees/ Degrees/ Degrees/ Degrees/ Degrees/ Degrees/ Degrees/ Degrees/ Degrees		Interchannel gain mismatch	- 6-dB full-scale AC-signal input		0.1		dB
mismatch 1-kHz sinusoidal signal 0.02 Degrees Phase drift(5) 1-kHz sinusoidal signal, across temperature range -40°C to 125°C 0.0005 Degrees/ PSRR Power-supply rejection ratio 100-mV _{PP} , 1-kHz sinusoidal signal on AVDD, differential input selected, 0-dB channel gain 102 dB CMRR Common-mode rejection ratio Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output 45 dB		Gain drift ⁽⁴⁾	Across temperature range -40°C to 125°C		50		ppm/°C
Phase drift [®] to 125°C 0.0005 Degrees/ PSRR Power-supply rejection ratio 100-mV _{PP} , 1-kHz sinusoidal signal on AVDD, differential input selected, 0-dB channel gain 102 dB CMRR Common-mode rejection ratio Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output 45 dB			1-kHz sinusoidal signal		0.02		Degrees
ratio input selected, 0-dB channel gain Common-mode rejection ratio Differential microphone input selected, 100-mV _{PP} , 1-kHz signal on both pins and measure level at output dB dB		Phase drift ⁽⁵⁾			0.0005		Degrees/°C
ratio signal on both pins and measure level at output 45 dB	PSRR	1			102		dB
NGITAL I/O	CMRR				45		dB
TOTALLO	DIGITAL I/	0					

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at $T_A = 25$ °C, AVDD = 3.3 V, IOVDD = 3.3 V, $f_{IN} = 1$ -kHz sinusoidal signal, $f_S = 48$ kHz, 32-bit audio data, BCLK = 256 × f_{S} , TDM slave mode (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Low-level digital input logic	All digital pins except FMT0, IOVDD 1.8-V operation	- 0.3		0.30 × IOVDD	V
V_{IL}	voltage threshold	All digital pins except FMT0, IOVDD 3.3-V operation	- 0.3		0.8	
		FMT0 Pin	- 0.3		0.8	V
		All digital pins except FMT0, IOVDD 1.8-V operation	0.7 × IOVDD	IO'	VDD + 0.3	V
V_{IH}	High-level digital input logic voltage threshold	All digital pins except FMT0, IOVDD 3.3-V operation	2.1	IO'	VDD + 0.3	V
	g	FMT0 Pin	2.1	A	0.8 IOVDD + 0.3 IOVDD + 0.3 AVDD + 0.3 0.45 0.4	V
\/	Low-level digital output	All digital pins, I _{OL} = -2 mA, IOVDD 1.8-V operation			0.45	V
V _{OL}	voltage	All digital pins, I _{OL} = -2 mA, IOVDD 3.3-V operation			0.4	V
V _{OH}	High-level digital output voltage	All digital pins, I _{OH} = 2 mA, IOVDD 1.8-V operation	IOVDD - 0.45			V
	voltage	All digital pins, I _{OH} = 2 mA, IOVDD 3.3-V operation	2.4			
I _{IH}	Input logic-high leakage for digital inputs	All digital pins, input = IOVDD	- 5	0.1	5	μΑ
I _{IL}	Input logic-low leakage for digital inputs	All digital pins, input = 0 V	- 5	0.1	5	μA
C _{IN}	Input capacitance for digital inputs	All digital pins		5		pF
R _{PD}	Pulldown resistance for digital I/O pins when asserted on			20		kΩ
TYPICAL	SUPPLY CURRENT CONSUMP	TION			1	
I _{AVDD}		AVDD = 3.3 V, internal AREG		0.5		mA
I _{IOVDD}	Current consumption with all Clocks disabled	All external clocks stopped, IOVDD = 3.3 V		0.5		
I _{IOVDD}	an ordens alsasies	All external clocks stopped, IOVDD = 1.8 V		0.3		μA
I _{AVDD}	Current consumption with	AVDD = 3.3 V, internal AREG		11.9		
I _{IOVDD}	ADC 2-channel operating at f _S 16-kHz, BCLK = 256 ×	IOVDD = 3.3 V		0.05		mA
I _{IOVDD}	f _S and DRE disabled	IOVDD = 1.8 V		0.02		
I _{AVDD}	Current consumption with	AVDD = 3.3 V, internal AREG		12.9		
I _{IOVDD}	ADC 2-channel operating at f _S 48-kHz, BCLK = 256 ×	IOVDD = 3.3 V		0.1		mA
I _{IOVDD}	f _S and DRE disabled	IOVDD = 1.8 V		0.05		
I _{AVDD}	Current consumption with	AVDD = 3.3 V, internal AREG		14		
I _{IOVDD}	ADC 2-channel operating at f _S 48-kHz, BCLK = 256 ×	IOVDD = 3.3 V		0.1		mA
I _{IOVDD}	f _S and DRE enabled	IOVDD = 1.8 V		0.05		

- (1) Ratio of output level with 1-kHz full-scale sine-wave input, to the output level with the AC signal input shorted to ground, measured Aweighted over a 20-Hz to 20-kHz bandwidth using an audio analyzer.
- All performance measurements done with a 20-kHz, low-pass filter and, where noted, an A-weighted filter. Failure to use such a filter may result in higher THD and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values.
- For best distortion performance, use input AC-coupling capacitors with a low-voltage-coefficient.
- Gain drift =gain_variation(in temperature range)/ typical gain value(gain at room temperature) / temperature range × 106 measured with gain in linear scale.
- Phase drift =phase deviation(in temperature range)/ (temperature range).

7.6 Timing Requirements: TDM or I²S Interface

at T_A = 25°C, IOVDD = 3.3 V or 1.8 V and 20-pF load on all outputs (unless otherwise noted)

			MIN	NOM MAX	UNIT
t _(BCLK)	BCLK period		40		ns
t _{H(BCLK)}	BCLK high pulse duration (1)		25		ns
t _{L(BCLK)}	BCLK low pulse duration (1)		25		ns
t _{SU(FSYNC)}	FSYNC setup time		8		ns
t _{HLD(FSYNC)}	FSYNC hold time		8		ns
t _{r(BCLK)}	BCLK rise time	10% - 90% rise time ⁽²⁾		10	ns



at T_A = 25°C, IOVDD = 3.3 V or 1.8 V and 20-pF load on all outputs (unless otherwise noted)

			MIN	NOM	MAX	UNIT
t _{f(BCLK)}	BCLK fall time	90% - 10% fall time ⁽²⁾			10	ns

- (1) The BCLK minimum high or low pulse duration can be relaxed to 14 ns (to meet the timing specifications), if the SDOUT data line is latched on the same BCLK edge polarity as the edge used by the device to transmit SDOUT data.
- (2) BCLK maximum rise and fall time can be relaxed to 13ns if BCLK frequency used in the system is below 20MHz. This can cause noise increase due to higher clock jitter.

7.7 Switching Characteristics: TDM or I²S Interface

at $T_A = 25^{\circ}$ C, IOVDD = 3.3 V or 1.8 V and 20-pF load on all outputs (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
t _{d(SDOUT-BCLK)}	BCLK to SDOUT delay	50% of BCLK to 50% of SDOUT	3	18	ns
$t_{d(SDOUT\text{-}FSYNC)}$	FSYNC to SDOUT delay in TDM mode (for MSB data with TX_OFFSET = 0)	50% of FSYNC to 50% of SDOUT		18	ns
f _(BCLK)	BCLK output clock frequency: master mode ⁽¹⁾			24.576	MHz
t _{H(BCLK)}	BCLK high pulse duration: master mode		14		ns
t _{L(BCLK)}	BCLK low pulse duration: master mode		14		ns
t _{d(FSYNC)}	BCLK to FSYNC delay: master mode	50% of BCLK to 50% of FSYNC	3	18	ns
t _{r(BCLK)}	BCLK rise time: master mode	10% - 90% rise time		8	ns
t _{f(BCLK)}	BCLK fall time: master mode	90% - 10% fall time		8	ns

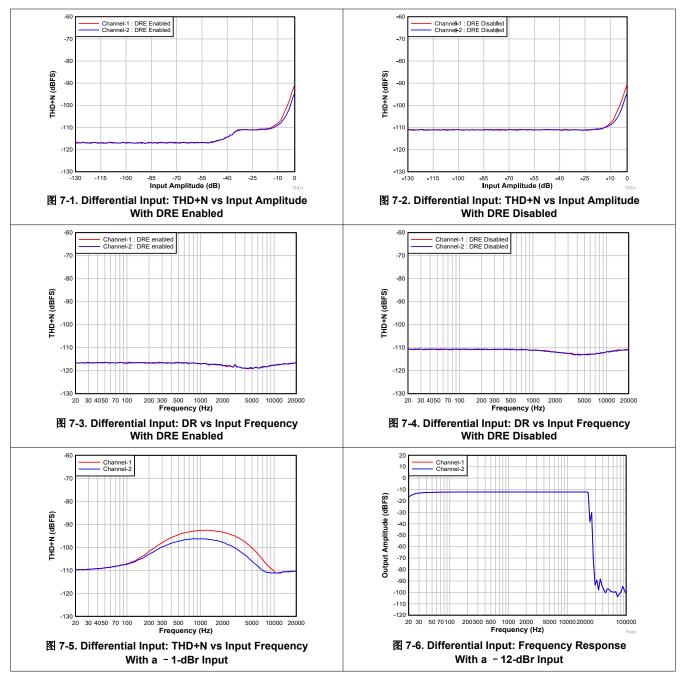
⁽¹⁾ The BCLK output clock frequency must be lower than 18.5 MHz (to meet the timing specifications), if the SDOUT data line is latched on the opposite BCLK edge polarity than the edge used by the device to transmit SDOUT data.

Product Folder Links: PCM1822



7.8 Typical Characteristics

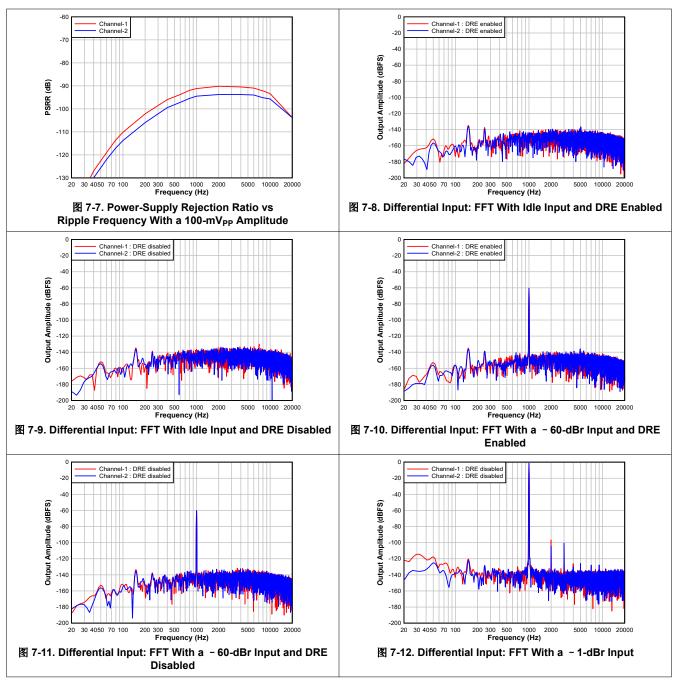
at T_A = 25°C, AVDD = 3.3 V, IOVDD = 3.3 V, f_{IN} = 1-kHz sinusoidal signal, f_S = 48 kHz, 32-bit audio data, BCLK = 256 × f_S , TDM slave mode, PLL on, DRE_LVL = - 36 dB, channel gain = 0 dB, and linear phase decimation filter (unless otherwise noted); all performance measurements are done with a 20-kHz, low-pass filter, and an A-weighted filter





7.8 Typical Characteristics (continued)

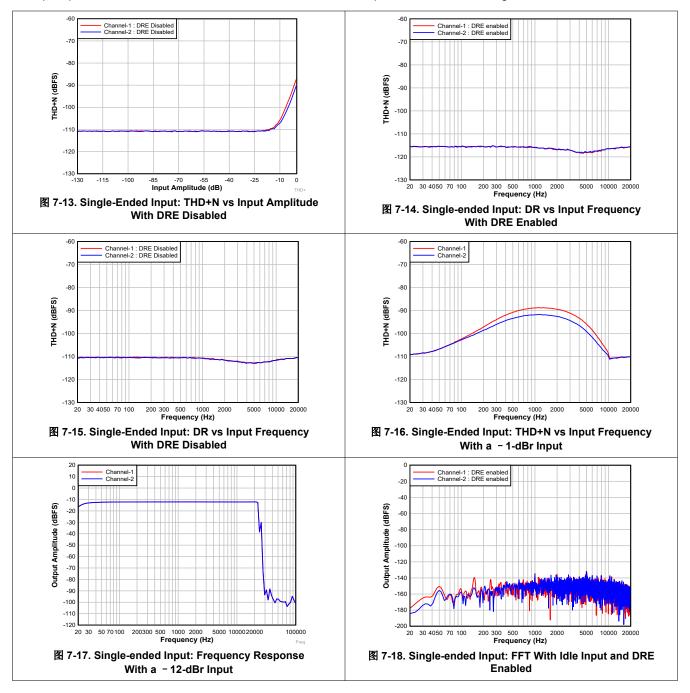
at T_A = 25°C, AVDD = 3.3 V, IOVDD = 3.3 V, f_{IN} = 1-kHz sinusoidal signal, f_S = 48 kHz, 32-bit audio data, BCLK = 256 × f_S , TDM slave mode, PLL on, DRE_LVL = -36 dB, channel gain = 0 dB, and linear phase decimation filter (unless otherwise noted); all performance measurements are done with a 20-kHz, low-pass filter, and an A-weighted filter





7.8 Typical Characteristics (continued)

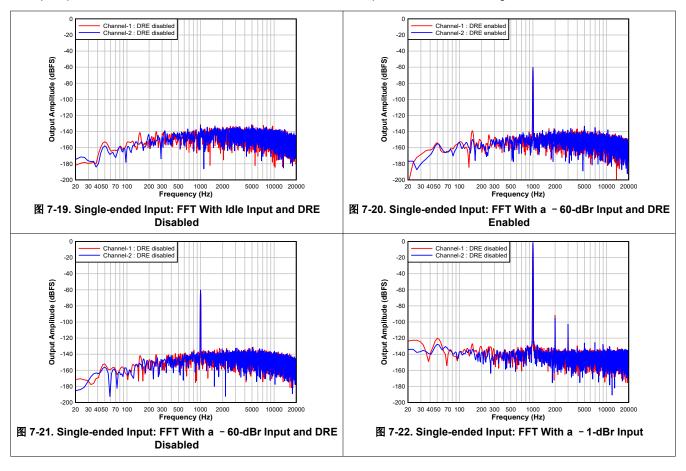
at T_A = 25°C, AVDD = 3.3 V, IOVDD = 3.3 V, f_{IN} = 1-kHz sinusoidal signal, f_S = 48 kHz, 32-bit audio data, BCLK = 256 × f_S , TDM slave mode, PLL on, DRE_LVL = -36 dB, channel gain = 0 dB, and linear phase decimation filter (unless otherwise noted); all performance measurements are done with a 20-kHz, low-pass filter, and an A-weighted filter





7.8 Typical Characteristics (continued)

at T_A = 25°C, AVDD = 3.3 V, IOVDD = 3.3 V, f_{IN} = 1-kHz sinusoidal signal, f_S = 48 kHz, 32-bit audio data, BCLK = 256 × f_S , TDM slave mode, PLL on, DRE_LVL = -36 dB, channel gain = 0 dB, and linear phase decimation filter (unless otherwise noted); all performance measurements are done with a 20-kHz, low-pass filter, and an A-weighted filter





8 Detailed Description

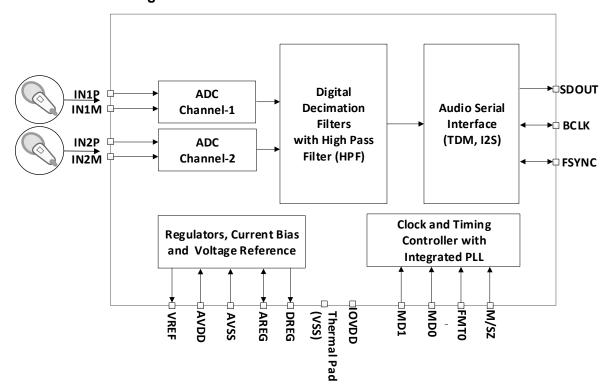
8.1 Overview

The PCM1822 is a high-performance, low-power, stereo-channel, audio analog-to-digital converter (ADC) with flexible audio interface control options. This device is intended for applications in voice-activated systems, AV receivers, tv and blu-ray players, professional microphones, audio conferencing, portable computing, communication, and entertainment applications. The high dynamic range of the device enables far-field audio recording with high fidelity. This device integrates a host of features that reduces cost, board space, and power consumption in space-constrained applications. The device features are controlled through hardware by pulling pins high or low with resistors or a controller general-purpose inut/output (GPIO). The PCM1822 also supports a power-down and reset function by means of halting the system clock.

The PCM1822 consists of the following blocks and features:

- Stereo-channel, multibit, high-performance delta-sigma ($\Delta \Sigma$) ADC
- Differential/Single-Ended audio inputs with a 1-V_{RMS} full-scale signal
- Hardware pin control operation to select the device features
- Audio bus serial interface master or slave select option
- Audio bus serial interface format select option
- Slave mode supports the audio bus serial interface up to 192 kHz sampling
- Slave mode supports a dynamic range enhancer (DRE) with 117-dB dynamic range for the PCM1822
- · Slave mode supports decimation filters with linear-phase or low-latency filter selection
- Master mode operation supported using a system clock of 256 × f_S or 512 × f_S
- · Power-down function by means of halting the audio clocks
- Integrated high-pass filter (HPF) that removes the DC component of the input signal
- Integrated low-jitter phase-locked loop (PLL) supporting a wide range of system clocks
- Integrated digital and analog voltage regulators to support single-supply, 3.3-V operation

8.2 Functional Block Diagram





8.3 Feature Description

8.3.1 Hardware Control

The device supports simple hardware-pin-controlled options to select a specific mode of operation and audio interface for a given system. The MSZ, MD0, MD1, and FMT0 pins allow the device to be controlled by either pullup or pulldown resistors.

8.3.2 Audio Serial Interfaces

Digital audio data flows between the host processor and the PCM1822 on the digital audio serial interface (ASI), or audio bus. This highly flexible ASI bus includes a TDM mode for multichannel operation, support for the I²S, and the pin-selectable master-slave configurability for bus clock lines.

The device supports an audio bus master or slave mode of operation using the hardware pin MSZ. In slave mode, FSYNC and BCLK work as input pins whereas in master mode, FSYNC and BCLK work as output pins generated by the device. 表 8-1 shows the master and slave mode selection using the MSZ pin.

表 8-1. Master and Slave Mode Selection

MSZ	MASTER AND SLAVE SELECTION
Low	Slave mode of operation
High	Master ode of operation

The bus protocol TDM or I^2S format can be selected by using the FMT0 pin. As shown in $\frac{1}{8}$ 8-2, these modes are all most significant byte (MSB)-first, pulse code modulation (PCM) data format, with an output channel data word-length of 32 bits.

表 8-2. Audio Serial Interface Format

FMT0	AUDIO SERIAL INTERFACE FORMAT
Low	2-channel output with inter IC sound (I ² S) mode
High	2-channel output with time division multiplexing (TDM) mode

8.3.2.1 Time Division Multiplexed Audio (TDM) Interface

In TDM mode, also known as DSP mode, the rising edge of FSYNC starts the data transfer with the slot 0 data first. Immediately after the slot 0 data transmission, the remaining slot data are transmitted in order. FSYNC and each data bit (except the MSB of slot 0 when TX_OFFSET equals 0) is transmitted on the rising edge of BCLK.

8 8-1 to 8 8-4 illustrate the protocol timing for TDM operation with various configurations.

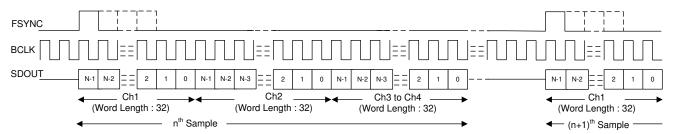


图 8-1. TDM Mode Protocol Timing (FMT0 = LOW) In Slave Mode



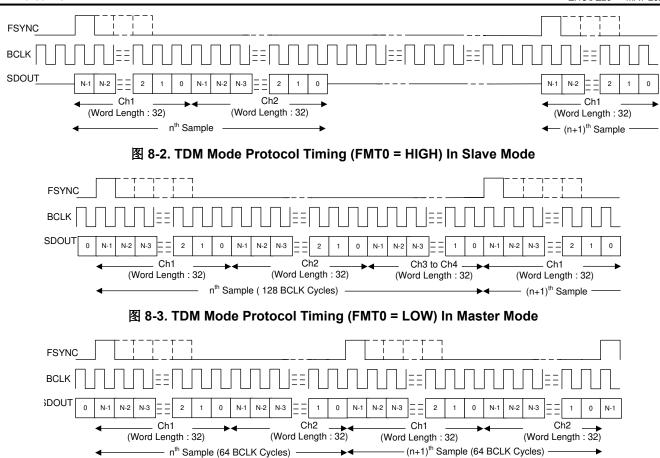


图 8-4. TDM Mode Protocol Timing (FMT0 = HIGH) In Master Mode

For proper operation of the audio bus in TDM mode, the number of bit clocks per frame must be greater than or equal to the number of active output channels times the 32-bits word length of the output channel data. The device transmits a zero data value on SDOUT for the extra unused bit clock cycles. The device supports FSYNC as a pulse with a 1-cycle-wide bit clock, but also supports multiples as well.

8.3.2.2 Inter IC Sound (I²S) Interface

The standard I^2S protocol is defined for only two channels: left and right. In I^2S mode, the MSB of the left slot 0 is transmitted on the falling edge of BCLK in the second cycle after the *falling* edge of FSYNC. The MSB of the right slot 0 is transmitted on the falling edge of BCLK in the second cycle after the *rising* edge of FSYNC. Each subsequent data bit is transmitted on the falling edge of BCLK. In master mode, FSYNC is transmitted on the rising edge of BCLK. 8-5 and 8-6 show the protocol timing for I^2S operation in slave and master mode of operation.

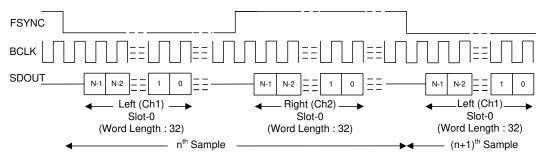


图 8-5. I²S Mode Protocol Timing in Slave Mode

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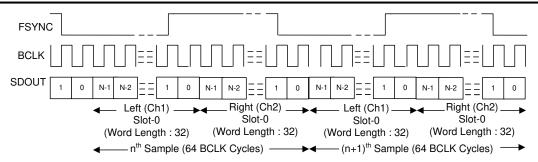


图 8-6. I²S Protocol Timing In Master Mode

For proper operation of the audio bus in I²S mode, the number of bit clocks per frame must be greater than or equal to the number of active output channels (including left and right slots) times the 32-bits word length of the output channel data. The device FSYNC low pulse must be a number of BCLK cycles wide that is greater than or equal to the number of active left slots times the 32-bits data word length. Similarly, the FSYNC high pulse must be a number of BCLK cycles wide that is greater than or equal to the number of active right slots times the 32-bits data word length. The device transmit zero data value on SDOUT for the extra unused bit clock cycles.

8.3.3 Phase-Locked Loop (PLL) and Clock Generation

The device uses an integrated, low-jitter, phase-locked loop (PLL) to generate internal clocks required for the ADC modulator and digital filter engine, as well as other control blocks.

In slave mode of operation, the device supports the various output data sample rates (of the FSYNC signal frequency) and the BCLK to FSYNC ratio to configure all clock dividers, including the PLL configuration, internally without host programming. $\frac{1}{8}$ 8-3 and $\frac{1}{8}$ 8-4 list the supported FSYNC and BCLK frequencies.

• • •		- ,		•	,	•	
	BCLK (MHz)						
BCLK TO FSYNC RATIO	FSYNC (8 kHz)	FSYNC (16 kHz)	FSYNC (24 kHz)	FSYNC (32 kHz)	FSYNC (48 kHz)	FSYNC (96 kHz)	FSYNC (192 kHz)
16	Reserved	0.256	0.384	0.512	0.768	1.536	3.072
24	Reserved	0.384	0.576	0.768	1.152	2.304	4.608
32	0.256	0.512	0.768	1.024	1.536	3.072	6.144
48	0.384	0.768	1.152	1.536	2.304	4.608	9.216
64	0.512	1.024	1.536	2.048	3.072	6.144	12.288
96	0.768	1.536	2.304	3.072	4.608	9.216	18.432
128	1.024	2.048	3.072	4.096	6.144	12.288	24.576
192	1.536	3.072	4.608	6.144	9.216	18.432	Reserved
256	2.048	4.096	6.144	8.192	12.288	24.576	Reserved
384	3.072	6.144	9.216	12.288	18.432	Reserved	Reserved
512	4.096	8.192	12.288	16.384	24.576	Reserved	Reserved

表 8-3. Supported FSYNC (Multiples or Submultiples of 48 kHz) and BCLK Frequencies

表 8-4. Supported FSYNC (Multiples or Submultiples of 44.1 kHz) and BCLK Frequencies

	BCLK (MHz)						
BCLK TO FSYNC RATIO	FSYNC (7.35 kHz)	FSYNC (14.7 kHz)	FSYNC (22.05 kHz)	FSYNC (29.4 kHz)	FSYNC (44.1 kHz)	FSYNC (88.2 kHz)	FSYNC (176.4 kHz)
16	Reserved	Reserved	0.3528	0.4704	0.7056	1.4112	2.8224
24	Reserved	0.3528	0.5292	0.7056	1.0584	2.1168	4.2336
32	Reserved	0.4704	0.7056	0.9408	1.4112	2.8224	5.6448
48	0.3528	0.7056	1.0584	1.4112	2.1168	4.2336	8.4672
64	0.4704	0.9408	1.4112	1.8816	2.8224	5.6448	11.2896
96	0.7056	1.4112	2.1168	2.8224	4.2336	8.4672	16.9344

Product Folder Links: PCM1822



表 8-4. Supported FSYNC (Multiples or Submultiples of 44.1 kHz) and BCLK Frequencies (continued)

	BCLK (MHz)						
BCLK TO FSYNC RATIO	FSYNC (7.35 kHz)	FSYNC (14.7 kHz)	FSYNC (22.05 kHz)	FSYNC (29.4 kHz)	FSYNC (44.1 kHz)	FSYNC (88.2 kHz)	FSYNC (176.4 kHz)
128	0.9408	1.8816	2.8224	3.7632	5.6448	11.2896	22.5792
192	1.4112	2.8224	4.2336	5.6448	8.4672	16.9344	Reserved
256	1.8816	3.7632	5.6448	7.5264	11.2896	22.5792	Reserved
384	2.8224	5.6448	8.4672	11.2896	16.9344	Reserved	Reserved
512	3.7632	7.5264	11.2896	15.0528	22.5792	Reserved	Reserved

In the master mode of operation, the device uses the MD1 pin (as the system clock, MCLK) as the reference input clock source with a supported system clock frequency option of either 256 × f_S or 512 × f_S as configured using the MD0 pin. Master mode supports f_S rates of 44.1 kHz and 48 kHz. $\frac{1}{8}$ 8-5 shows the system clock selection for the master mode using the MD0 pin.

表 8-5. System Clock Selection for the Master Mode

MD0	SYSTEM CLOCK SELECTION (Valid for Master Mode Only)
LOW	System clock with frequency 256 × f _S connected to the MD1 pin as MCLK
HIGH	System clock with frequency 512 × f _S connected to the MD1 pin as MCLK

See 表 8-7 and 表 8-20 for the MD0 and MD1 pin function in the slave mode of operation.

8.3.4 Input Channel Configurations

The device consists of two pairs of analog input pins (INxP and INxM) as differential inputs for the recording channel. The device supports simultaneous recording of up to two channels using the high-performance stereo ADC. The input source for the analog pins can be from electret condenser analog microphones, micro electrical-mechanical system (MEMS) analog microphones, or line-in (auxiliary) inputs from the system board.

The voice or audio signal inputs must be capacitively coupled (AC-coupled) to the device and, for best distortion performance, use the low-voltage coefficient capacitors for AC coupling. The typical input impedance for the PCM1822 is $2.5~k~\Omega$ for the INxP or INxM pins. The value of the coupling capacitor in AC-coupled mode must be chosen so that the high-pass filter formed by the coupling capacitor and the input impedance do not affect the signal content. Before proper recording can begin, this coupling capacitor must be charged up to the common-mode voltage at power-up. To enable quick charging, the device has a quick charge scheme to speed up the charging of the coupling capacitor at power-up. The default value of the quick-charge timing is set for a coupling capacitor up to 1 μ F.

8.3.5 Reference Voltage

All audio data converters require a DC reference voltage. The PCM1822 achieves low-noise performance by internally generating a low-noise reference voltage. This reference voltage is generated using a band-gap circuit with high PSRR performance. This audio converter reference voltage must be filtered externally using a minimum 1- μ F capacitor connected from the VREF pin to analog ground (AVSS). The value of this reference voltage, VREF, is set to 2.75 V, which in turn supports a 2-V_{RMS} differential full-scale input to the device. The required minimum AVDD voltage for this VREF voltage is 3 V. Do not connect any external load to a VREF pin.

8.3.6 Signal-Chain Processing

The PCM1822 signal chain is comprised of very-low-noise, high-performance, and low-power analog blocks and highly flexible and programmable digital processing blocks. The high performance and flexibility combined with a compact package makes the PCM1822 optimized for a variety of end-equipments and applications that require multichannel audio capture. 8-7 shows a conceptual block diagram for the PCM1822 that highlights the various building blocks used in the signal chain, and how the blocks interact in the signal chain. The PCM1822 does not support DRE.

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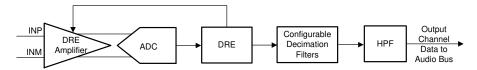


图 8-7. Signal-Chain Processing Flowchart

The front-end dynamic range enhancer (DRE) gain amplifier in the PCM1822 is very low noise, with a 117-dB dynamic range performance. Along with a low-noise and low-distortion, multibit, delta-sigma ADC, the front-end DRE gain amplifier enables the PCM1822 to record a far-field audio signal with very high fidelity, both in quiet and loud environments. Moreover, the ADC architecture has inherent antialias filtering with a high rejection of out-of-band frequency noise around multiple modulator frequency components. Therefore, the device prevents noise from aliasing into the audio band during ADC sampling. Further on in the signal chain, an integrated, high-performance multistage digital decimation filter sharply cuts off any out-of-band frequency noise with high stop-band attenuation.

The device supports an input signal bandwidth up to 80 kHz, which allows the high-frequency non-audio signal to be recorded by using a 176.4-kHz (or higher) sample rate.

8.3.6.1 Digital High-Pass Filter

To remove the DC offset component and attenuate the undesired low-frequency noise content in the record data, the device supports a fixed high-pass filter (HPF) with -3-dB cut-off frequency of $0.00025 \times f_S$. The HPF is not a channel-independent filter but is globally applicable for all the ADC channels. This HPF is constructed using the first-order infinite impulse response (IIR) filter, and is efficient enough to filter out possible DC components of the signal. $\frac{1}{8}$ 8-6 shows the fixed -3-dB cutoff frequency value. 8-8 shows a frequency response plot for the HPF filter.

表 8-6. HPF Cutoff Frequency Value

-3-dB CUTOFF FREQUENCY VALUE	-3-dB CUTTOFF FREQUENCY AT 16 kHz SAMPLE RATE	-3-dB CUTTOFF FREQUENCY AT 48 kHz SAMPLE RATE
0.00025 × f _S	4 Hz	12 Hz

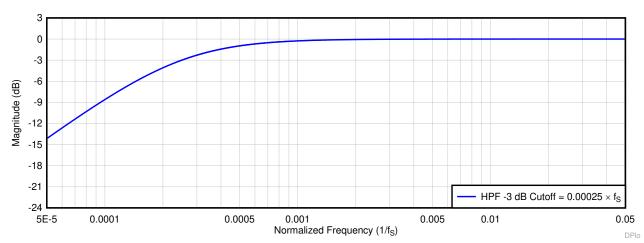


图 8-8. HPF Filter Frequency Response Plot



8.3.6.2 Configurable Digital Decimation Filters

The device record channel includes a high dynamic range, built-in digital decimation filter to process the oversampled data from the multibit delta-sigma ($\Delta \Sigma$) modulator to generate digital data at the same Nyquist sampling rate as the FSYNC rate. The decimation filter can be chosen from two different types only in slave mode, depending on the required frequency response, group delay, and phase linearity requirements for the target application. The selection of the decimation filter option can be done by the MD0 pin. $\frac{1}{8}$ 8-7 shows the decimation filter mode selection for the record channel.

表 8-7. Decimation Filter Mode Selection for the Record Channel

MD0	DECIMATION FILTER MODE SELECTION (Supported Only in Slave Mode)
LOW	Linear phase filters are used for the decimation in slave mode. For master mode, the device always use linear phase filters for the decimation.
HIGH	Low latency filters are used for the decimation in slave mode. For master mode, the device always use linear phase filters for the decimation.

8.3.6.2.1 Linear Phase Filters

The linear phase decimation filters are the default filters set by the device and can be used for all applications that require a perfect linear phase with zero-phase deviation within the pass-band specification of the filter. The filter performance specifications and various plots for all supported output sampling rates are listed in this section.

8.3.6.2.1.1 Sampling Rate: 8 kHz or 7.35 kHz

图 8-9 and 图 8-10 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 8 kHz or 7.35 kHz. 表 8-8 lists the specifications for a decimation filter with an 8-kHz or 7.35-kHz sampling rate.

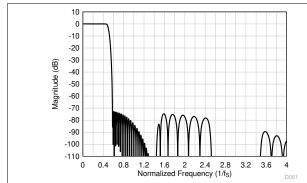


图 8-9. Linear Phase Decimation Filter Magnitude Response

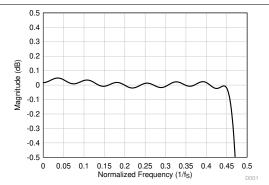


图 8-10. Linear Phase Decimation Filter Pass-Band Ripple

表 8-8. Linear Phase Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Pass-band ripple	Frequency range is 0 to 0.454 × f _S	- 0.05		0.05	dB	
Otan hand attanuation	Frequency range is 0.58 × f _S to 4 × f _S	72.7			dB	
Stop-band attenuation	Frequency range is 4 × f _S onwards	81.2			uБ	
Group delay or latency	Frequency range is 0 to 0.454 × f _S		17.1		1/f _S	

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8.3.6.2.1.2 Sampling Rate: 16 kHz or 14.7 kHz

图 8-11 and 图 8-12 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 16 kHz or 14.7 kHz. 表 8-9 lists the specifications for a decimation filter with an 16-kHz or 14.7-kHz sampling rate.

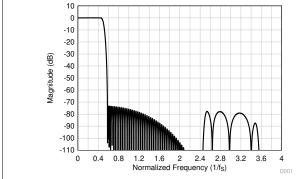


图 8-11. Linear Phase Decimation Filter Magnitude Response

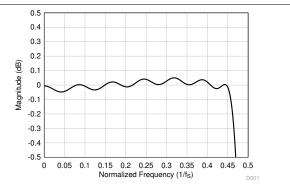


图 8-12. Linear Phase Decimation Filter Pass-Band Ripple

表 8-9. Linear Phase Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Pass-band ripple	Frequency range is 0 to 0.454 × f _S	- 0.05		0.05	dB	
Stop-band attenuation	Frequency range is 0.58 × f _S to 4 × f _S	73.3			- dB	
	Frequency range is 4 × f _S onwards	95.0				
Group delay or latency	Frequency range is 0 to 0.454 × f _S		15.7		1/f _S	

8.3.6.2.1.3 Sampling Rate: 24 kHz or 22.05 kHz

图 8-13 and 图 8-14 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 24 kHz or 22.05 kHz. 表 8-10 lists the specifications for a decimation filter with an 24-kHz or 22.05-kHz sampling rate.

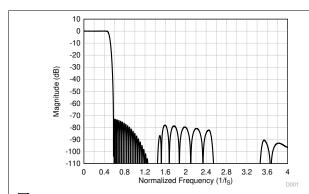


图 8-13. Linear Phase Decimation Filter Magnitude Response

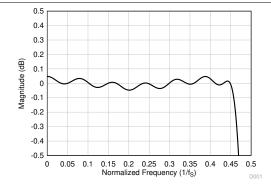


图 8-14. Linear Phase Decimation Filter Pass-Band Ripple

表 8-10. Linear Phase Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Pass-band ripple	Frequency range is 0 to 0.454 × f _S - 0.05			0.05	dB
Stop-band attenuation	Frequency range is 0.58 × f _S to 4 × f _S	73.0			dB
Stop-band attendation	Frequency range is 4 × f _S onwards	96.4			uБ



表 8-10. Linear Phase Decimation Filter Specifications (continued)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Group delay or latency	Frequency range is 0 to 0.454 × f _S		16.6		1/f _S

8.3.6.2.1.4 Sampling Rate: 32 kHz or 29.4 kHz

图 8-15 and 图 8-16 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 32 kHz or 29.4 kHz. 表 8-11 lists the specifications for a decimation filter with an 32-kHz or 29.4-kHz sampling rate.

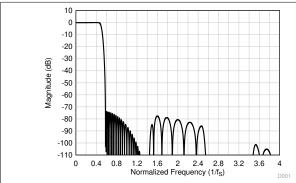


图 8-15. Linear Phase Decimation Filter Magnitude Response

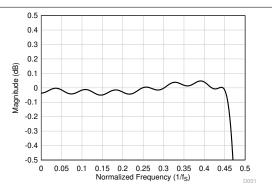


图 8-16. Linear Phase Decimation Filter Pass-Band Ripple

表 8-11. Linear Phase Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Pass-band ripple	Frequency range is 0 to 0.454 × f _S	- 0.05		0.05	dB	
Stop-band attenuation	Frequency range is 0.58 × f _S to 4 × f _S	73.7			dB	
Stop-band attenuation	Frequency range is 4 × f _S onwards	107.2			uБ	
Group delay or latency	Frequency range is 0 to 0.454 × f _S		16.9		1/f _S	

8.3.6.2.1.5 Sampling Rate: 48 kHz or 44.1 kHz

图 8-17 and 图 8-18 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 48 kHz or 44.1 kHz. 表 8-12 lists the specifications for a decimation filter with an 48-kHz or 44.1-kHz sampling rate.

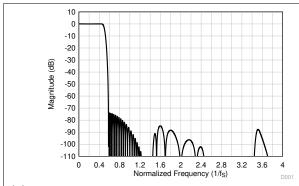


图 8-17. Linear Phase Decimation Filter Magnitude Response

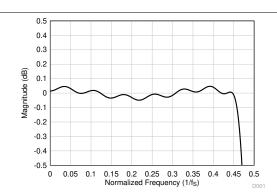


图 8-18. Linear Phase Decimation Filter Pass-Band Ripple



表 8-12. Linear Phase Decimation Filter Specifications

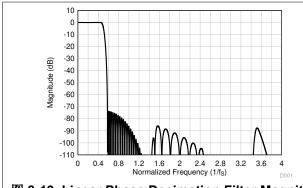
PARAMETER	TEST CONDITIONS MIN TYP		TYP	MAX	UNIT	
Pass-band ripple	Frequency range is 0 to 0.454 × f _S	- 0.05		0.05	dB	
Stop-band attenuation	Frequency range is 0.58 × f _S to 4 × f _S	73.8			dB	
Stop-barid atteridation	Frequency range is 4 × f _S onwards	98.1			uБ	
Group delay or latency	Frequency range is 0 to 0.454 × f _S		17.1		1/f _S	

8.3.6.2.1.6 Sampling Rate: 96 kHz or 88.2 kHz

图 8-19 and 图 8-20 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 96 kHz or 88.2 kHz. 表 8-13 lists the specifications for a decimation filter with an 96-kHz or 88.2-kHz sampling rate.

0.5 0.4

0.3



0.2 0.1 0.1 0.2 0.3 0.4 0.5 0 0.05 0.1 0.15 0.2 0.25 0.3 0.35 0.4 0.45 0.5 Normalized Frequency (1/fs)

图 8-19. Linear Phase Decimation Filter Magnitude Response

图 8-20. Linear Phase Decimation Filter Pass-Band Ripple

表 8-13. Linear Phase Decimation Filter Specifications

	· · · · · · · · · · · · · · · · · · ·					
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Pass-band ripple	Frequency range is 0 to 0.454 × f _S	- 0.05		0.05	dB	
Stop-band attenuation	Frequency range is 0.58 × f _S to 4 × f _S	73.6			- dB	
Stop-parid atteridation	Frequency range is 4 × f _S onwards	97.9			uБ	
Group delay or latency	Frequency range is 0 to 0.454 × f _S	17.1		1/f _S		

8.3.6.2.1.7 Sampling Rate: 192 kHz or 176.4 kHz

图 8-21 and 图 8-22 respectively show the magnitude response and the pass-band ripple for a decimation filter with a sampling rate of 192 kHz or 176.4 kHz. 8-14 lists the specifications for a decimation filter with an 192-kHz or 176.4-kHz sampling rate.

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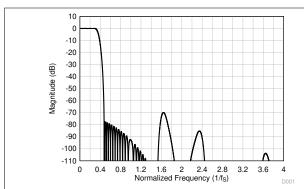


图 8-21. Linear Phase Decimation Filter Magnitude Response

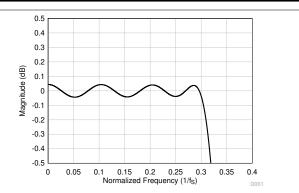


图 8-22. Linear Phase Decimation Filter Pass-Band Ripple

表 8-14. Linear Phase Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Pass-band ripple	Frequency range is 0 to 0.3 × f _S	- 0.05		0.05	dB	
Stop-band attenuation	Frequency range is 0.473 × f _S to 4 × f _S	70.0			dB	
Stop-parid attenuation	Frequency range is 4 × f _S onwards	111.0			uБ	
Group delay or latency	Frequency range is 0 to 0.3 × f _S		11.9		1/f _S	

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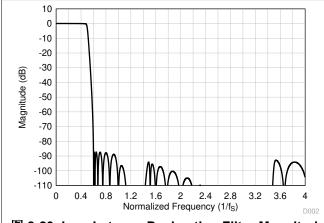


8.3.6.2.2 Low-Latency Filters

For applications where low latency with minimal phase deviation (within the audio band) is critical, the low-latency decimation filters on the PCM1822 can be used. The device supports these filters with a group delay of approximately seven samples with an almost linear phase response within the $0.365 \times f_S$ frequency band. This section provides the filter performance specifications and various plots for all supported output sampling rates for the low-latency filters.

8.3.6.2.2.1 Sampling Rate: 16 kHz or 14.7 kHz

图 8-23 shows the magnitude response and 图 8-24 shows the pass-band ripple and phase deviation for a decimation filter with a sampling rate of 16 kHz or 14.7 kHz. 表 8-15 lists the specifications for a decimation filter with a 16-kHz or 14.7-kHz sampling rate.



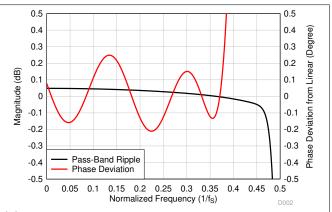


图 8-23. Low-Latency Decimation Filter Magnitude Response

图 8-24. Low-Latency Decimation Filter Pass-Band Ripple and Phase Deviation

表 8-15. Low-Latency Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Pass-band ripple	Frequency range is 0 to 0.451 × f _S	- 0.05 0.05		dB	
Stop-band attenuation	Frequency range is 0.61 × f _S onwards	1 × f _S onwards 87.3		dB	
Group delay or latency	Frequency range is 0 to 0.363 × f _S	7.6			1/f _S
Group delay deviation	Frequency range is 0 to 0.363 × f _S	- 0.022		0.022	1/f _S
Phase deviation	Frequency range is 0 to 0.363 × f _S	- 0.21 0.25		Degrees	

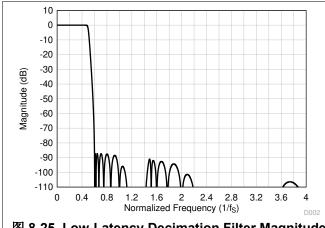
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8.3.6.2.2.2 Sampling Rate: 24 kHz or 22.05 kHz

图 8-25 shows the magnitude response and 图 8-26 shows the pass-band ripple and phase deviation for a decimation filter with a sampling rate of 24 kHz or 22.05 kHz. 表 8-16 lists the specifications for a decimation filter with a 24-kHz or 22.05-kHz sampling rate.



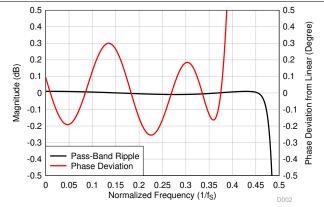


图 8-25. Low-Latency Decimation Filter Magnitude Response

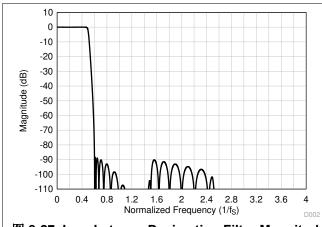
图 8-26. Low-Latency Decimation Filter Pass-Band Ripple and Phase Deviation

表 8-16. Low-Latency Decimation Filter Specifications

PARAMETER	TEST CONDITIONS MIN TYP MAX		UNIT		
Pass-band ripple	Frequency range is 0 to 0.459 × f _S - 0.01		0.01	dB	
Stop-band attenuation	Frequency range is 0.6 × f _S onwards	87.2		dB	
Group delay or latency	Frequency range is 0 to 0.365 × f _S	7.5			1/f _S
Group delay deviation	Frequency range is 0 to 0.365 × f _S	- 0.026		0.026	1/f _S
Phase deviation	Frequency range is 0 to 0.365 × f _S	- 0.26 0.30		Degrees	

8.3.6.2.2.3 Sampling Rate: 32 kHz or 29.4 kHz

图 8-27 shows the magnitude response and 图 8-28 shows the pass-band ripple and phase deviation for a decimation filter with a sampling rate of 32 kHz or 29.4 kHz. 表 8-17 lists the specifications for a decimation filter with a 32-kHz or 29.4-kHz sampling rate.



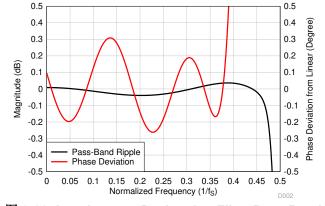


图 8-27. Low-Latency Decimation Filter Magnitude Response

图 8-28. Low-Latency Decimation Filter Pass-Band Ripple and Phase Deviation

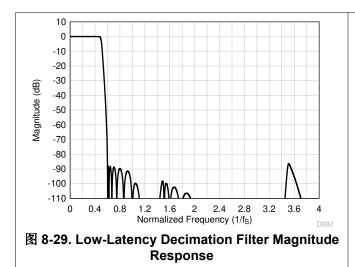


表 8-17. Low-Latency Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Pass-band ripple	Frequency range is 0 to 0.457 × f _S	- 0.04		0.04	dB
Stop-band attenuation	Frequency range is 0.6 × f _S onwards	88.3		dB	
Group delay or latency	Frequency range is 0 to 0.368 × f _S	8.7		1/f _S	
Group delay deviation	Frequency range is 0 to 0.368 × f _S	- 0.026 0.026		1/f _S	
Phase deviation	Frequency range is 0 to 0.368 × f _S	- 0.26		0.31	Degrees

8.3.6.2.2.4 Sampling Rate: 48 kHz or 44.1 kHz

图 8-29 shows the magnitude response and 图 8-30 shows the pass-band ripple and phase deviation for a decimation filter with a sampling rate of 48 kHz or 44.1 kHz. 表 8-18 lists the specifications for a decimation filter with a 48-kHz or 44.1-kHz sampling rate.



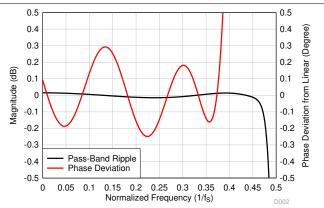


图 8-30. Low-Latency Decimation Filter Pass-Band **Ripple and Phase Deviation**

表 8-18. Low-Latency Decimation Filter Specifications

PARAMETER	TEST CONDITIONS	MIN TYP MAX		UNIT	
Pass-band ripple	Frequency range is 0 to 0.452 × f _S	- 0.015		0.015	dB
Stop-band attenuation	Frequency range is 0.6 × f _S onwards	86.4		dB	
Group delay or latency	Frequency range is 0 to 0.365 × f _S	7.7			1/f _S
Group delay deviation	Frequency range is 0 to 0.365 × f _S	- 0.027		0.027	1/f _S
Phase deviation	Frequency range is 0 to 0.365 × f _S	- 0.25		0.30	Degrees

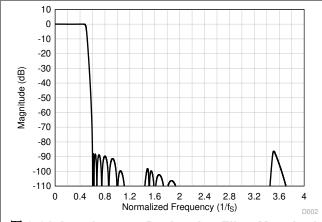
Product Folder Links: PCM1822

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8.3.6.2.2.5 Sampling Rate: 96 kHz or 88.2 kHz

图 8-31 shows the magnitude response and 图 8-32 shows the pass-band ripple and phase deviation for a decimation filter with a sampling rate of 96 kHz or 88.2 kHz. 表 8-19 lists the specifications for a decimation filter with a 96-kHz or 88.2-kHz sampling rate.



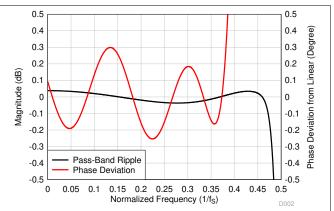


图 8-31. Low-Latency Decimation Filter Magnitude Response

图 8-32. Low-Latency Decimation Filter Pass-Band Ripple and Phase Deviation

表 8-19. Low-Latency Decimation Filter Specifications

,, , , , , , , , , , , , , , , , , , ,					
PARAMETER	TEST CONDITIONS MIN TYP MAX		UNIT		
Pass-band ripple	Frequency range is 0 to 0.466 × f _S	ange is 0 to 0.466 × f _S - 0.04 0.04		0.04	dB
Stop-band attenuation	Frequency range is 0.6 × f _S onwards	86.3		dB	
Group delay or latency	Frequency range is 0 to 0.365 × f _S	7.7			1/f _S
Group delay deviation	Frequency range is 0 to 0.365 × f _S	- 0.027 0.027		1/f _S	
Phase deviation	Frequency range is 0 to 0.365 × f _S	- 0.26 0.30 E		Degrees	

8.3.7 Dynamic Range Enhancer (DRE)

The device integrates an ultra-low noise front-end DRE gain amplifier with 117-dB dynamic range performance with a low-noise, low-distortion, multibit delta-sigma ($\Delta \Sigma$) ADC with a 111-dB dynamic range. The dynamic range enhancer (DRE) is a digitally assisted algorithm to boost the overall channel performance. The DRE monitors the incoming signal amplitude and accordingly adjusts the internal DRE amplifier gain automatically. The DRE achieves a complete-channel dynamic range as high as 117 dB. At a system level, the DRE scheme enables far-field, high-fidelity recording of audio signals in very quiet environments and low-distortion recording in loud environments.

The DRE can be enabled only in slave mode by driving the MD1 pin high. 表 8-20 shows the DRE selection for the record channel.

表 8-20. DRE Selection for the Record Channel

MD1	DRE SELECTION (Supported Only in Slave Mode)
Low	The DRE is disabled in slave mode. For master mode, the DRE is always disabled.
	The DRE is enabled with DRE_LVL = - 36 dB and DRE_MAXGAIN = 18 dB in slave mode. For master mode, the DRE is always disabled.

This algorithm is implemented with very low latency and all signal chain blocks are designed to minimize any audible artifacts that may occur resulting from dynamic gain modulation. The target signal threshold level (DRE_LVL), at which the DRE is triggered, is fixed to the - 36-dB input signal level. The DRE gain range can be dynamically modulated by using DRE_MAXGAIN, which is fixed to 18 dB to maximize the benefit of the DRE in real-world applications and to minimize any audible artifacts.

Enabling the DRE for processing increases the power consumption of the device because of increased signal processing. Therefore, disable the DRE for low-power critical applications. Furthermore, the DRE is not supported for output sample rates greater than 48 kHz.

8.4 Device Functional Modes

8.4.1 Active Mode

The device wakes up in active mode when AVDD and IOVDD are available. Configure all hardware control pins (MSZ, MD0, MD1, and FMT0) for the device desired mode of operation before enabling clocks for the device.

In active mode, when the audio clocks are available, the device automatically powers up all ADC channels and starts transmitting data over the audio serial interface. If the clocks are stopped, then the device auto powers down the ADC channels.

Product Folder Links: PCM1822

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9 Application and Implementation

备注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9.1 Application Information

The PCM1822 is a multichannel, high-performance audio analog-to-digital converter (ADC) that supports output sample rates of up to 192 kHz. The device supports up to two analog microphones for simultaneous recording applications.

The PCM1822 configuration is supported using various hardware pin control options. The device supports a highly flexible, audio serial interface (TDM and I²S) to transmit audio data seamlessly in the system across devices.

9.2 Typical Application

Solution 9-1 shows a typical configuration of the PCM1822 for an application using stereo analog microelectrical-mechanical system (MEMS) microphones for simultaneous recording operation with a time-division multiplexing (TDM) audio data slave interface. For best distortion performance, use input AC-coupling capacitors with a low-voltage coefficient.

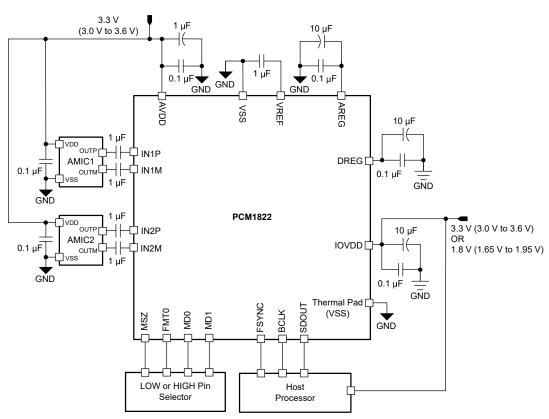


图 9-1. Two-Channel Analog Microphone Recording Diagram for 3.3-V AVDD Operation

ZHCSQ26 - MAY 2022



9.2.1 Design Requirements

表 9-1 lists the design parameters for this application.

表 9-1. Design Parameters

KEY PARAMETER	SPECIFICATION: 3.3-V AVDD OPERATION		
AVDD	3.3 V		
AVDD supply current consumption	12.9 mA (two-channel recording, f _S = 48 kHz)		
IOVDD	1.8 V or 3.3 V		

9.2.2 Detailed Design Procedure

This section describes the necessary steps to configure the PCM1822 for this specific application. The following steps provide a sequence of steps that must be executed in the time between powering the device up and reading data from the device or transitioning from one mode to another mode of operation.

- 1. Apply power to the device:
 - a. Power-up the IOVDD and AVDD power supplies
 - b. The device now goes into low-power mode
- 2. Configure the pins for correct configuration:
 - a. Connect the MSZ, FMT0, MD0, and MD1 pin voltages for the desired configuration
 - b. Apply FSYNC and BCLK with the desired output sample rates and the BCLK to FSYNC ratio

 See the *Phase-Locked Loop (PLL) and Clock Generation* section for supported sample rates and the BCLK to FSYNC ratio
 - c. The device recording data are now sent to the host processor via the audio serial data bus
- 3. Stop the clocks to stop recording of data at any time

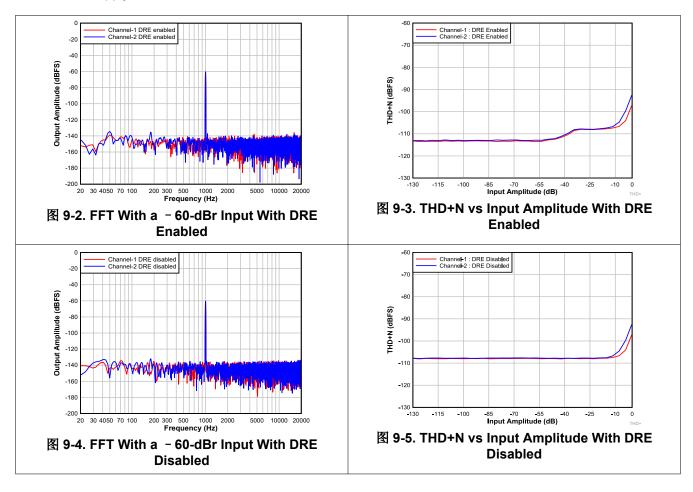
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9.2.3 Application Curves

Measurements are done on the EVM by feeding the device analog input signal using audio precision and with a 3.3-V AVDD supply.





10 Power Supply Recommendations

The power-supply sequence between the IOVDD and AVDD rails can be applied in any order. However, do not provide any clocks until the IOVDD and AVDD supply voltage settles to a stable and supported operating voltage range. Provide the clocks (FSYNC and BCLK) only when all hardware control pins (MSZ, MD0, MD1, FMT0, and FMT1) are driven to the voltage level for the device desired mode of operation.

For the supply power-up requirement, t_1 and t_2 must be at least 100 µs. For the supply power-down requirement, t_3 and t_4 must be at least 10 ms. This timing (as shown in 200 10-1) allows the device to ramp down the volume on the record data, power down the analog and digital blocks, and put the device into hardware shutdown mode.

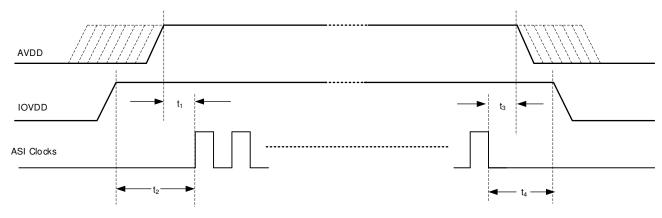


图 10-1. Power-Supply Sequencing Requirement Timing Diagram

Make sure that the supply ramp rate is slower than 1 V/µs and that the wait time between a power-down and a power-up event is at least 100 ms.

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11 Layout

11.1 Layout Guidelines

Each system design and printed circuit board (PCB) layout is unique. The layout must be carefully reviewed in the context of a specific PCB design. However, the following guidelines can optimize the device performance:

- Connect the thermal pad to ground. Use a via pattern to connect the device thermal pad, which is the area directly under the device, to the ground planes. This connection helps dissipate heat from the device.
- The decoupling capacitors for the power supplies must be placed close to the device pins.
- Route the analog differential audio signals differentially on the PCB for better noise immunity. Avoid crossing
 digital and analog signals to prevent undesirable crosstalk.
- The device internal voltage references must be filtered using external capacitors. Place the filter capacitors near the VREF pin for optimal performance.
- Directly short the VREF external capacitor ground terminal to the AVSS pin without using any vias for this connection trace.
- Use ground planes to provide the lowest impedance for power and signal current between the device and the
 decoupling capacitors. Treat the area directly under the device as a central ground area for the device, and
 all device grounds must be connected directly to that area.

11.2 Layout Example

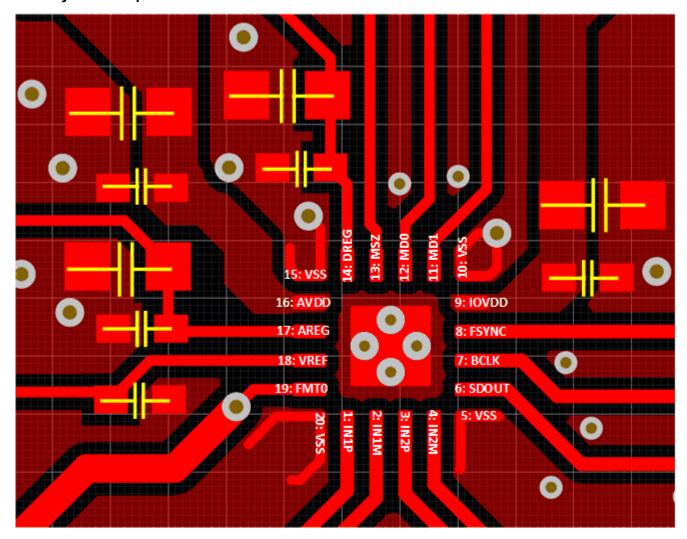


图 11-1. Example Layout



12 Device and Documentation Support

12.1 接收文档更新通知

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12.2 支持资源

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12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 术语表

TI术语表本术语表列出并解释了术语、首字母缩略词和定义。

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
PCM1822IRTER	Active	Production	WQFN (RTE) 20	3000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	PC1822
PCM1822IRTER.A	Active	Production	WQFN (RTE) 20	3000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	PC1822

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF PCM1822:

Automotive : PCM1822-Q1

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



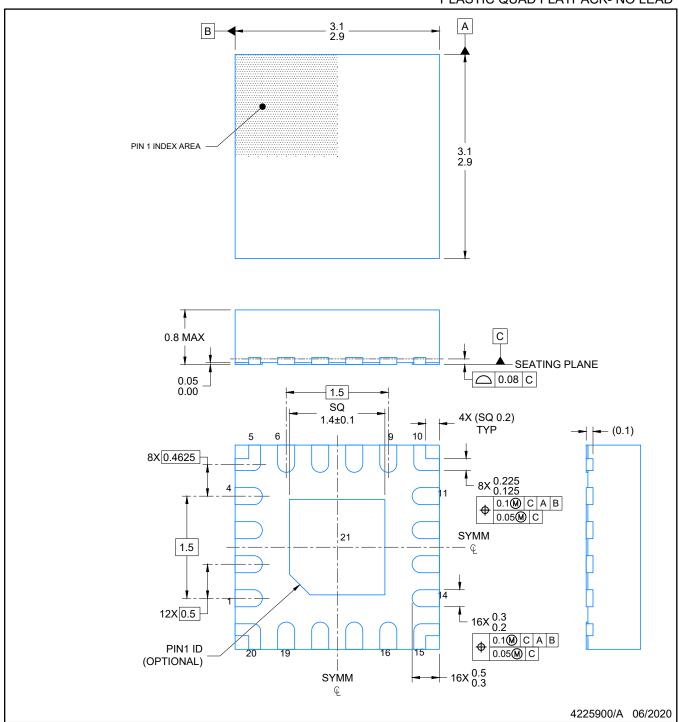
PACKAGE OPTION ADDENDUM

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NOTE	: Qu	alified	Version	Definitions

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

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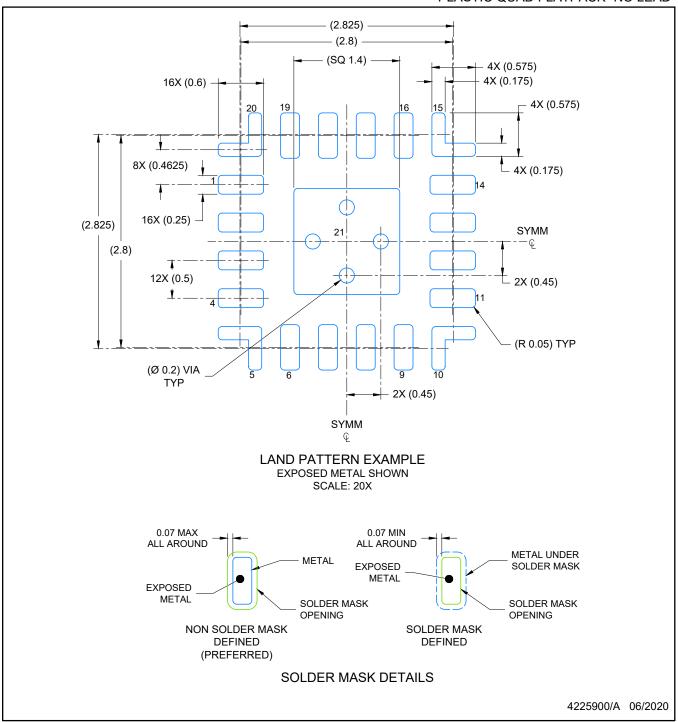


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



PLASTIC QUAD FLATPACK- NO LEAD

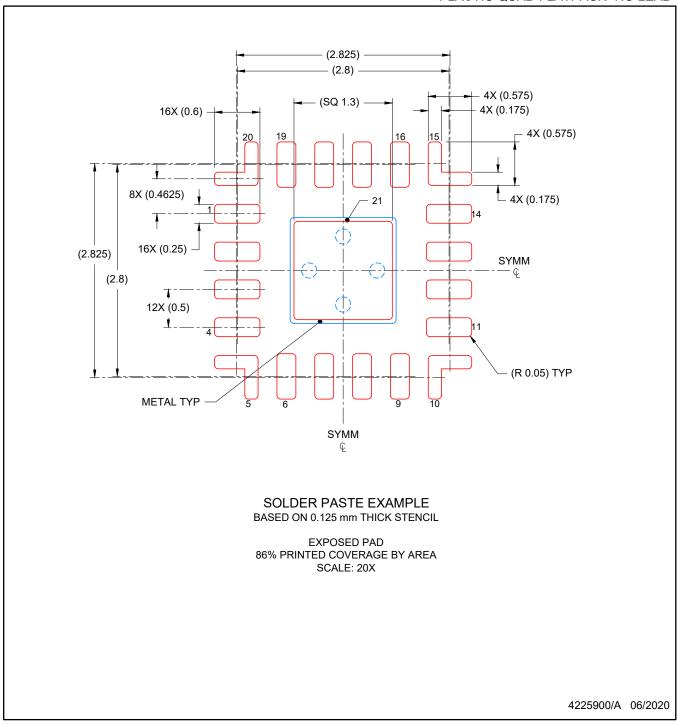


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK- NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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最后更新日期: 2025 年 10 月